



Programmable Analog for High Power LED Color Mixing Applications

By (Gavin Hesse, PSoC Product Marketing Engineer, Cypress Semiconductor Corp. and
Patrick Prendergast, PSoC Applications Engineer, Cypress Semiconductor Corp.)

Executive Summary

Programmable analog circuitry adds analog functionality to reprogrammable digital electronics. The combination provides flexibility to end users and offers unique advantages to designers in particular applications. For instance, High Power LED color mixing applications have relatively loose timing requirements, but there are nine parameters that need to be measured in a typical RGBW (red, green, blue, white) application: four LED forward voltage signals, four LED current waveforms, and the board temperature. Each signal type requires a different signal conditioning topology. The optimal solution to measure each signal accurately is programmable analog.

Introduction

In High Power LED applications such as architectural lighting and LCD backlighting, color accuracy is the most important electronic design consideration. The ideal solution to achieve this accuracy is to measure the wavelengths produced by the lighting system with a color sensor. Without this sensor additional challenges are created, requiring the lighting circuit to measure, control or calculate all of the parameters that affect the performance of the LED.

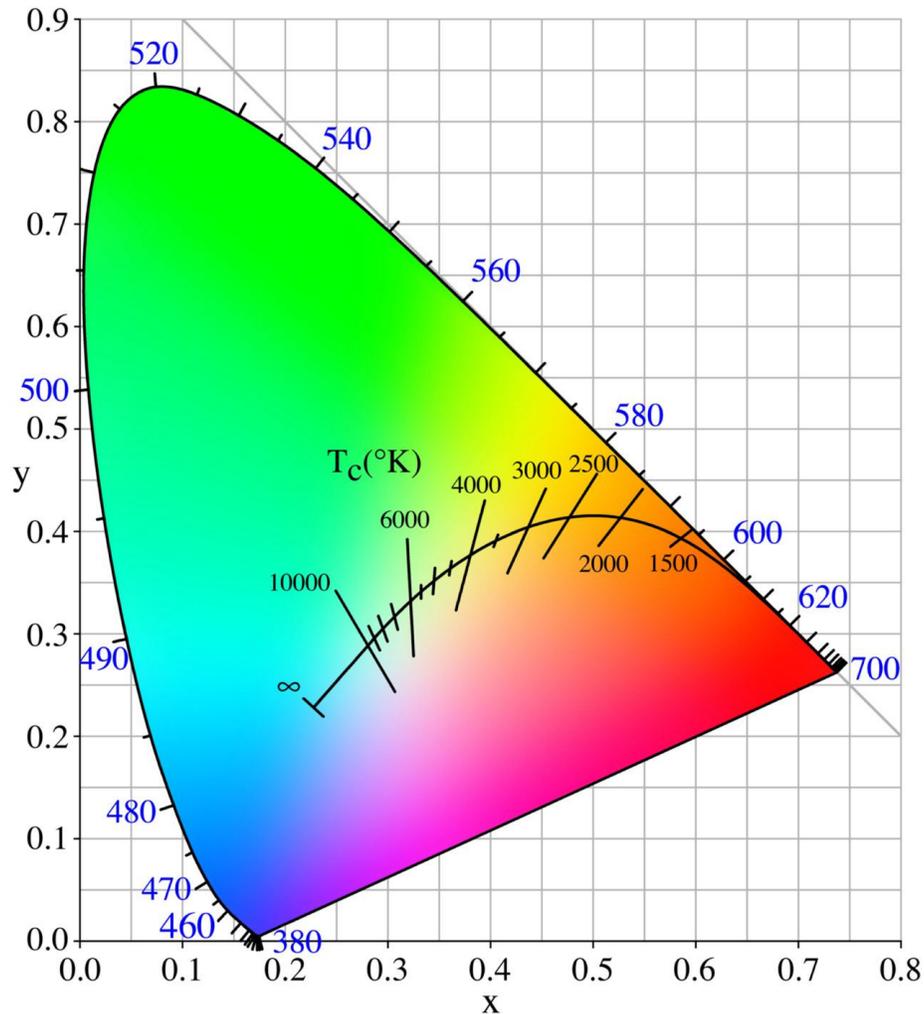
The ecosystem of a High Power LED design presents unique challenges, as it requires expertise in widely variant areas. To accurately mix color the system must have adequate electronic, thermal and optical design elements. The electronic aspect will measure the forward voltage, current, and board temperature signals. The number of parameters affects the potential size and cost of the analog circuit itself, obviously a concern for engineers everywhere. The thermal design is potentially the most overlooked, as LEDs do not radiate heat similar to an Edison lightbulb, but instead conduct it through the junction to the mount. The junction temperature therefore can fluctuate wildly if there is a lack of attention to the type of board connection, be it epoxy, grease or solder. The junction temperature affects the luminous flux and the dominant wavelength of the LED, both of which affect the mixed color generated by the overall system of LEDs. Finally, optical design knowledge is necessary to diffuse the output of each LED to create the appropriate color, necessary for there to be little variance between manufactured boards.

Color mixing is done by dimming each LED a calculated amount and diffusing the light generated by the lighting system. While working with these LEDs on the bench diffusing the light is extremely important, the intensity of the output may damage your eyes. Any engineer who remembers the birth of laser pointers will remember the spots that stayed in their vision for hours when the personal experiments in high school involved direct exposure to the beam. To solve this problem, it is recommended to radiate the LEDs into a simple diffusing material such as paper, a Styrofoam cup or the inside of a white box. Still, take care and avoid exposure to direct radiation.

Correlated Color Temperature or Chromaticity Coordinates

Chromaticity coordinates are a unit of measure which provides a set of (x, y) coordinates for each color in the visible spectrum; the 1931 CIE color chart, shown in figure 1, has become the de facto standard for specifying color in lighting designs. Correlated color temperature is a unit of measure that describes a color near the Planckian locus (black-body radiation curve) in the CIE color space.

Figure 1: 1931 CIE Color Chart with Correlated Color Temperature



The 1931 CIE color chart is shown in figure 1, color points are usually defined by picking an acceptable range of x and y values for each color. The CIE chart is useful for specifying color mix points in the project planning phase. For most applications red, green and blue (RGB) LEDs will be used to create a particular color point. Remember back to preschool and the first indoctrination into the magical world of fingerpaints, and the color mixing method becomes clear. Yellow plus Blue still makes Green.

The color temperature parameter is useful for specifying types of white light. The Planckian locus, shown in figure 1, runs right through the middle of the white region of the CIE chart and it is easier for the brain to process a number than a set of coordinates.

It is important to note that color temperature is somewhat unintuitive because “hotter” whites have a blue tint and “cool” whites are tinted towards yellow, orange or red. Still, the color temperature is converted to a chromaticity coordinate region for processing. In multicolored designs chromaticity coordinates from the 1931 CIE color chart are the preferred measure of performance and accuracy, as the level of complexity in working with multiple color temperature numbers for each LED gets unwieldy quickly.

An example of this is shown in figure 2. Six different sets of chromaticity coordinates are given:

Red – (.6875, .3010) (.6930, .3045) (.7150, .2750) (.7200, .2800)

Green – (.0250, .5100) (.0250, .7000) (.2000, .4100) (.2500, .5000)

Blue – (.1200, .1000) (.1300, .4300) (.1700, .1500) (.1700, .0750)

Yellow/Amber – (.5700, .4250) (.5850, .4075) (.5750, .4225) (.5875, .4100)

Violet/Purple – (.2550, .1750) (.2450, .1500) (.3200, .1800) (.3225, .1500)

White – (.3270, .3400) (.3270, .3200) (.3500, .3675) (.3500, .3300)

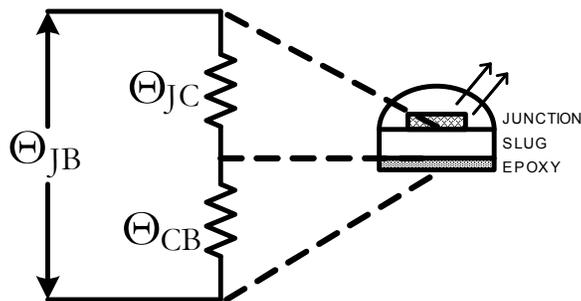
The set of four coordinates gives a box of allowable color gamut for the application. When the LEDs are plotted in the figure, it is seen that the Amber coordinate box is unreachable. In order to increase the size of the valid region, another LED has to be added, in this case an Amber LED.

Temperature Concerns

As the temperature of the lighting system increases the performance of each LED deteriorates, as the luminous flux decreases and the dominant wavelength increases. To compensate for the degradation in the luminous flux, the LED has to be driven harder to account for the lost light output, which can result in a thermal runaway condition and eventual destruction of the LED. Since, as stated earlier, High Power LEDs conduct heat through the junction, a rapid thermal runaway could introduce safety issues for consumer devices. Proper care must be taken to either shut the system down or to meet the color point at a safer intensity level. As the dominant wavelength increases the dimming values for each LED need to be recalculated to ensure that the targeted color point is still being met at the elevated temperature.

Because the LED temperature changes relatively slowly, the measurements to determine the temperature can be thought of as nearly static. This affords the designer greater flexibility in the way measurements are taken. Reading junction temperature directly is not possible, because there is thermal impedance from the junction to the slug and from the slug to the board as shown in figure 3.

Figure 3: LED Thermal Resistance Model



The parameter that can be measured is the LED board temperature, which is measured using a thermistor or other temperature sensor. A thermistor is a low cost device and the preferred solution. This board temperature only provides an ambient measurement, so equation 1 is used to find a reasonable approximation of the junction temperature of each LED.

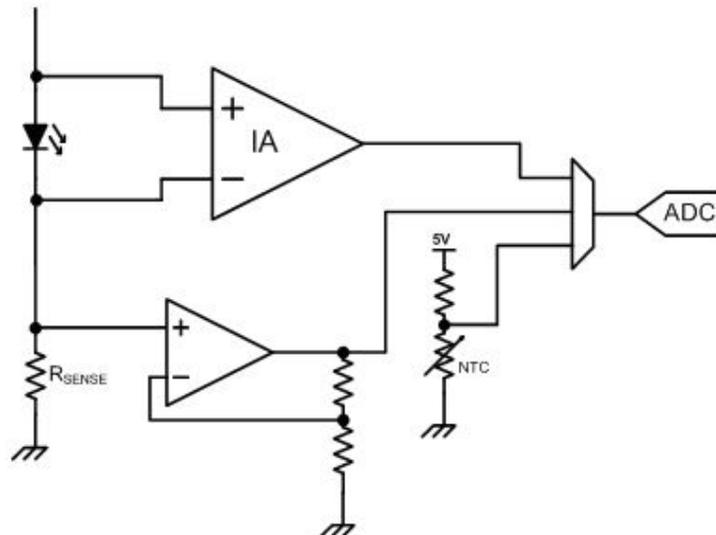
Equation 1: LED Junction Temperature

$$T_J = T_B + \Theta_{JB} I_{LED} V_f$$

How is it done?

In a RGBW design nine parameters need to be quantified, four current sense signals, four LED forward voltage signals and one board temperature signal. A simple solution is to provide a signal conditioning circuit for each signal and then multiplex the conditioned signals. With this method only one ADC is used, but there are nine separate signal conditioning circuits, one LED circuit is shown in figure 4. This circuit is simple, but includes many passive and active components, which will increase BOM size and cost of the system. The circuit is redundant, in that each of the current sense or forward voltage signal conditioning circuits are the same.

Figure 4: Signal Conditioning Circuit for One LED



The redundancy in methodology can be eliminated by adding an analog MUX to the front end of each signal conditioning circuit. For example, figure 5 shows a low-side current sense circuit, notice that only one amplifier and one set of passives is required to measure the four signals thanks to the analog MUX at the front end. Repeat the procedure for the forward voltage measurement. Now there are three signals to be multiplexed to the ADC (figure 6) and the circuit is a third of the size as the circuit in figure 4.

Figure 5: Low Side Current Sense With Front-End Analog MUX

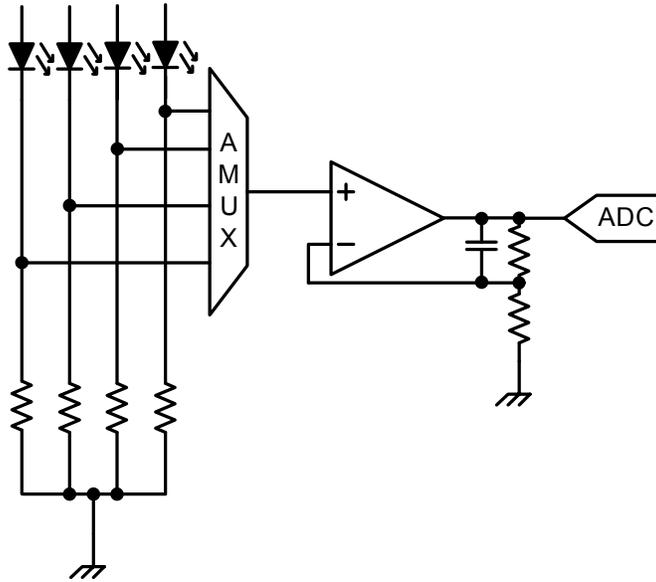
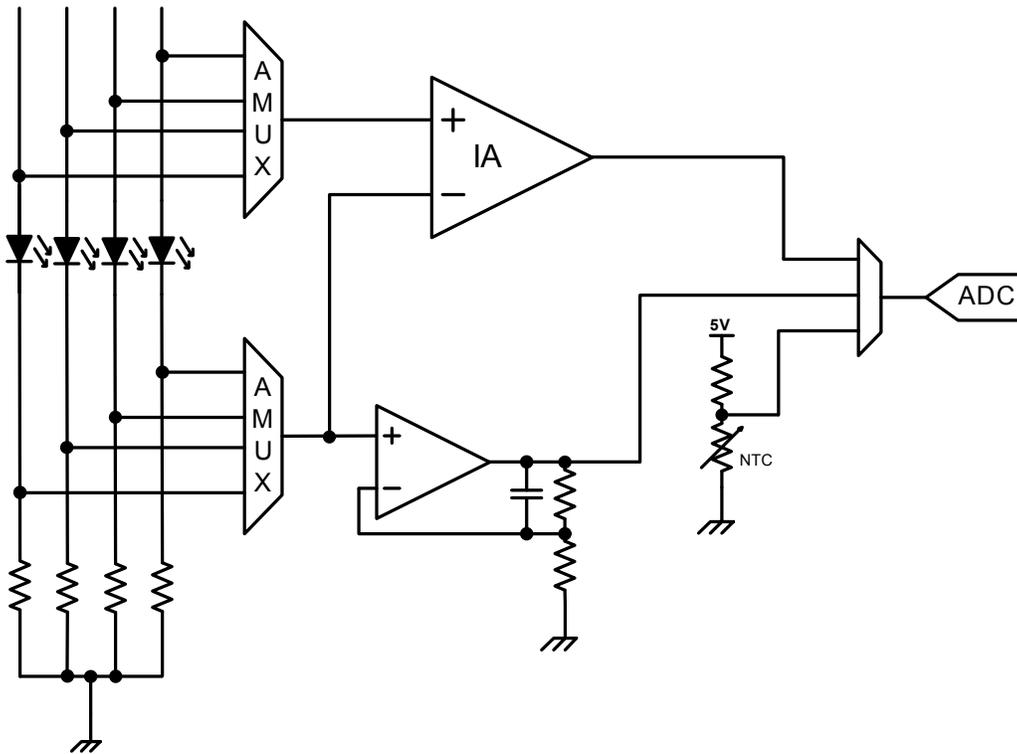


Figure 6: Two Front End Analog MUXs Reduce the Size of the Analog Circuit

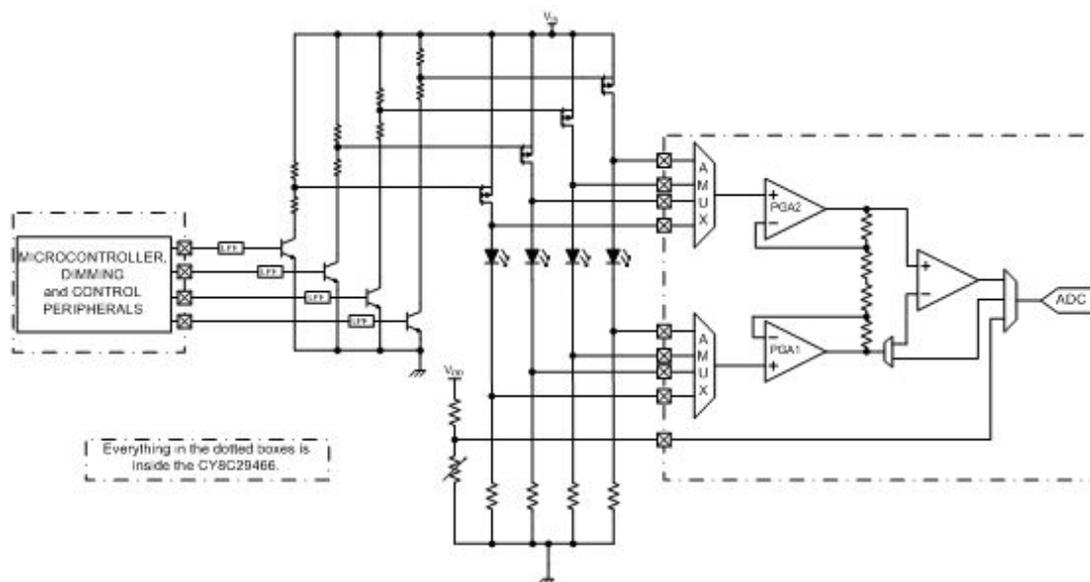


Programmable analog

Programmable logic chips start out looking like NO gates, nothing gets in and nothing gets out. This functionality can be beneficial because the chips can be configured to perform just about any digital function. Still, one constant problem is that they don't like analog signals and analog signal designers generally don't like them. Recent advances in technology have made it possible for programmable digital and analog functionality to exist on the same device, such as the Cypress PSoC family and the Analog Devices ADuC8xx family.

The promise of programmable analog chips is that designers will have the flexibility to reconfigure analog circuits on the fly. This in-system reconfigurability is useful for a variety of applications, such as LED color mixing, where a dynamic solution makes the circuit in figure 6 simple to implement, as shown in figure 7. Additionally, the reconfigurable analog enables further reduction in circuit size by adding the ability to change the gain, amplifier configuration, filter settings and ADC settings. For example, look at figure 7; in one configuration PGA1 acts as a current sense amplifier and in another configuration it acts as an input stage for the instrumentation amplifier measuring the differential LED forward voltage. The configurations are controlled by an on chip microcontroller; the microcontroller processes the ADC data, controls the LED drive and changes the analog configuration.

Figure 7: CY8C27443 Implementation of the Application Circuit



ASICs provide some of the same flexibility of programmable analog ICs because the circuit in figure 6 can be pulled into the IC. The obvious advantage to ASIC design is that the designer gets what they want. At the start of the project the system requirements, and the requirements for the ASIC, are defined. Ideally, the requirements at the beginning of the project are the same as the requirements at the end of the project. Unfortunately, project requirements rarely remain consistent from beginning to end, engineers blame this as "marketing". When these changes appear, ASIC development must be modified or completely redesigned, which creates a significant resource and money issue for companies.

The advantage of programmable analog ICs over ASICs is that the chip can be reprogrammed as the project requirements change. If an LED design begins as RGB, but needs to move to RGBW, a programmable IC adds another signal input to the MUX at the front end, configures the gain appropriately from the op amp, adds an internal filter, and uses the internal ADC, all without affecting the RGB design already in place. In practice, the same chip selected at the beginning of a project still works at the end of a project, and most manufacturers create programmable ICs to be forwards-backwards compatible if more memory or internal resources are needed.



The Cypress PSoC mixed-signal controller has a unique architecture that allows the digital and analog resources to be reconfigured for different analog input signals. In this case the analog input circuit in figure 7 works as both an instrumentation amplifier, for measuring the LED forward voltage, and as a non-inverting amplifier for amplifying the voltage on the current sense resistors and NTC thermistor. The amplifier changes from an instrumentation amplifier (INSAMP) (shown) to a non-inverting amplifier (PGA) (not shown) by changing the connection point of the internal resistor string. In the INSAMP configuration, the bottom of each amplifier's resistor string are tied to each other. In the PGA configuration the bottom of the resistor strings are tied to V_{SS} .

PSoC analog circuitry has the additional functionality of a configurable analog multiplexer. The PSoC multiplexer can be configured as 8:1 multiplexer for measuring as many as eight single-ended inputs, such as thermistors. The multiplexer can also be configured as two 4:1 multiplexers for measuring up to 4 differential signals. In this particular application, there are three differential signal (LED forward voltages) and one single-ended signal (thermistor) are controlled with the same multiplexer. In this case the forward voltage and current of three different LEDs and a thermistor are measured.

Conclusion

The High Power LED marketplace is ripe for engineers of all stripes to originate new ideas and applications, as it moves towards being a ten billion dollar market in the next few years. The ability to create rich colors across the visible spectrum with a solution that has a longer life and greater efficiency is opening up opportunities from lightbulb vendors to LCD TV manufacturers. Designers attempting to enter this market would be well served to understand the advantages programmable ICs offer to make their jobs that much easier. From cutting down the bill of materials using the internal front end muxes to dynamically reconfiguring the analog circuit for each individual signal, programmable ICs can provide a cheap, accurate solution for color mixing applications.

It's also fun.



References

Cypress Semiconductor
198 Champion Court
San Jose, CA 95134-1709
Phone: 408-943-2600
Fax: 408-943-4730
<http://www.cypress.com>

© Cypress Semiconductor Corporation, 2007. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

PSoC Designer™, Programmable System-on-Chip™, and PSoC Express™ are trademarks and PSoC® is a registered trademark of Cypress Semiconductor Corp. All other trademarks or registered trademarks referenced herein are property of the respective corporations.

This Source Code (software and/or firmware) is owned by Cypress Semiconductor Corporation (Cypress) and is protected by and subject to worldwide patent protection (United States and foreign), United States copyright laws and international treaty provisions. Cypress hereby grants to licensee a personal, non-exclusive, non-transferable license to copy, use, modify, create derivative works of, and compile the Cypress Source Code and derivative works for the sole purpose of creating custom software and or firmware in support of licensee product to be used only in conjunction with a Cypress integrated circuit as specified in the applicable agreement. Any reproduction, modification, translation, compilation, or representation of this Source Code except as specified above is prohibited without the express written permission of Cypress.

Disclaimer: CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Cypress reserves the right to make changes without further notice to the materials described herein. Cypress does not assume any liability arising out of the application or use of any product or circuit described herein. Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress' product in a life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Use may be limited by and subject to the applicable Cypress software license agreement.